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Kind regards,

Team Nexperia



**PBHV9040T**500 V, 0.25 A PNP high-voltage low V<sub>CEsat</sub> (BISS) transistorRev. 02 - 15 January 2009Product data sheet

### 1. Product profile

### 1.1 General description

PNP high-voltage low  $V_{CEsat}$  Breakthrough In Small Signal (BISS) transistor in a SOT23 (TO-236AB) small Surface-Mounted Device (SMD) plastic package.

NPN complement: PBHV8540T.

#### 1.2 Features

- High voltage
- Low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability I<sub>C</sub> and I<sub>CM</sub>
- High collector current gain (h<sub>FE</sub>) at high I<sub>C</sub>
- AEC-Q101 qualified

### **1.3 Applications**

- Electronic ballast for fluorescent lighting
- LED driver for LED chain module
- LCD backlighting
- High Intensity Discharge (HID) front lighting
- Automotive motor management
- Hook switch for wired telecom
- Switch mode power supply

### 1.4 Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CESM</sub>	collector-emitter peak voltage	$V_{BE} = 0 V$	-	-	-500	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	-400	V
I <sub>C</sub>	collector current		-	-	-0.25	А
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = -10 V; I <sub>C</sub> = -50 mA	100	200	-	



500 V, 0.25 A PNP high-voltage low V<sub>CEsat</sub> (BISS) transistor

# 2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	base		
2	emitter		3
3	collector		1
			sym013

# 3. Ordering information

Table 3. Order	ing information	on	
Type number	Package		
	Name	Description	Version
PBHV9040T	-	plastic surface-mounted package; 3 leads	SOT23

# 4. Marking

Table 4.	Marking codes	
Type num	ber	Marking code <sup>[1]</sup>
PBHV904	т	W5*

[1] \* = -: made in Hong Kong

\* = p: made in Hong Kong

\* = t: made in Malaysia

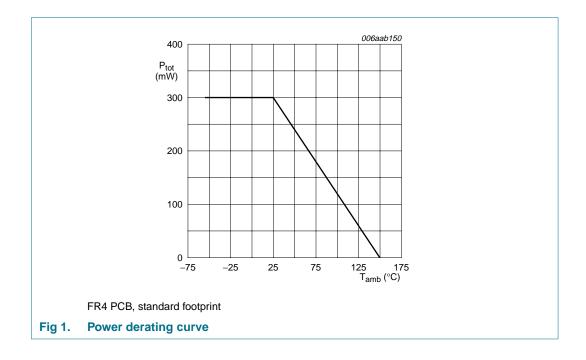
\* = W: made in China

### 500 V, 0.25 A PNP high-voltage low V<sub>CEsat</sub> (BISS) transistor

# 5. Limiting values

Table 5. In accorda	Limiting values nce with the Absolute Maximu	m Rating System (IE	C 60134).		
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter	-	-500	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-400	V
V <sub>CESM</sub>	collector-emitter peak voltage	$V_{BE} = 0 V$	-	-500	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	-6	V
I <sub>C</sub>	collector current		-	-0.25	А
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$	-	-0.5	A
I <sub>BM</sub>	peak base current	single pulse; $t_p \leq 1 \text{ ms}$	-	-200	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u>	300	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

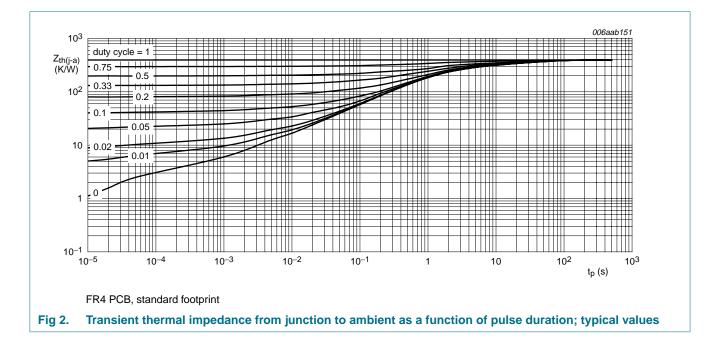


### 500 V, 0.25 A PNP high-voltage low V<sub>CEsat</sub> (BISS) transistor

# 6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u> -	-	417	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		-	-	70	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.



500 V, 0.25 A PNP high-voltage low V<sub>CEsat</sub> (BISS) transistor

# 7. Characteristics

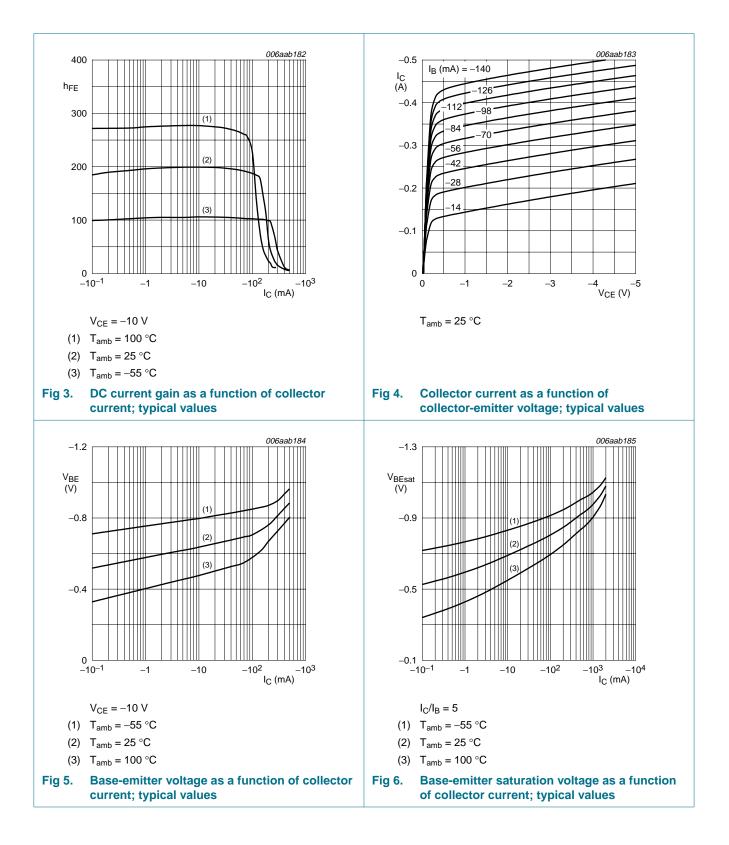
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>CBO</sub>	collector-base cut-off	$V_{CB} = -320 \text{ V}; \text{ I}_{E} = 0 \text{ A}$		-	-	-100	nA
	current	$\label{eq:VCB} \begin{array}{l} V_{CB} = -320 \ V; \ I_E = 0 \ A; \\ T_j = 150 \ ^\circC \end{array}$		-	-	-10	μΑ
I <sub>CES</sub>	collector-emitter cut-off current	$V_{CE} = -320 \text{ V}; V_{BE} = 0 \text{ V}$		-	-	-100	nA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -4 \text{ V}; \text{ I}_{C} = 0 \text{ A}$		-	-	-100	nA
h <sub>FE</sub> DC current gain	DC current gain	$V_{CE} = -10 \text{ V}$					
		$I_{\rm C}$ = -50 mA		100	200	-	
		$I_{\rm C} = -100  {\rm mA}$		80	200	-	
		$I_{\rm C} = -250 \text{ mA}$	[1]	10	25	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{\rm C}$ = -100 mA; $I_{\rm B}$ = -20 mA		-	-110	-200	mV
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_{\rm C}$ = -100 mA; $I_{\rm B}$ = -20 mA	<u>[1]</u>	-	–1	-1.1	V
f <sub>T</sub>	transition frequency	$V_{CE} = -10 \text{ V}; I_E = -10 \text{ mA};$ f = 100 MHz		-	55	-	MHz
C <sub>c</sub>	collector capacitance	$\label{eq:VCB} \begin{array}{l} V_{CB}=-20 \text{ V}; \text{ I}_{E}=\text{i}_{e}=0 \text{ A};\\ \text{f}=1 \text{ MHz} \end{array}$		-	7	-	pF
C <sub>e</sub>	emitter capacitance	$\label{eq:Veb} \begin{array}{l} V_{EB}=-0.5 \text{ V}; \text{ I}_{C}=\text{i}_{c}=0 \text{ A};\\ \text{f}=1 \text{ MHz} \end{array}$		-	150	-	pF
t <sub>d</sub>	delay time	$V_{CC} = -2 \text{ V}; \text{ I}_{C} = -0.15 \text{ A};$		-	9	-	ns
t <sub>r</sub>	rise time	$I_{Bon} = -0.03 \text{ A};$		-	1810	-	ns
t <sub>on</sub>	turn-on time	$I_{Boff} = 0.03 \text{ A}$		-	1819	-	ns
t <sub>s</sub>	storage time			-	715	-	ns
t <sub>f</sub>	fall time			-	1085	-	ns
t <sub>off</sub>	turn-off time			-	1800	-	ns

[1] Pulse test:  $t_p \le 300 \ \mu s$ ;  $\delta \le 0.02$ .

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# **PBHV9040T**

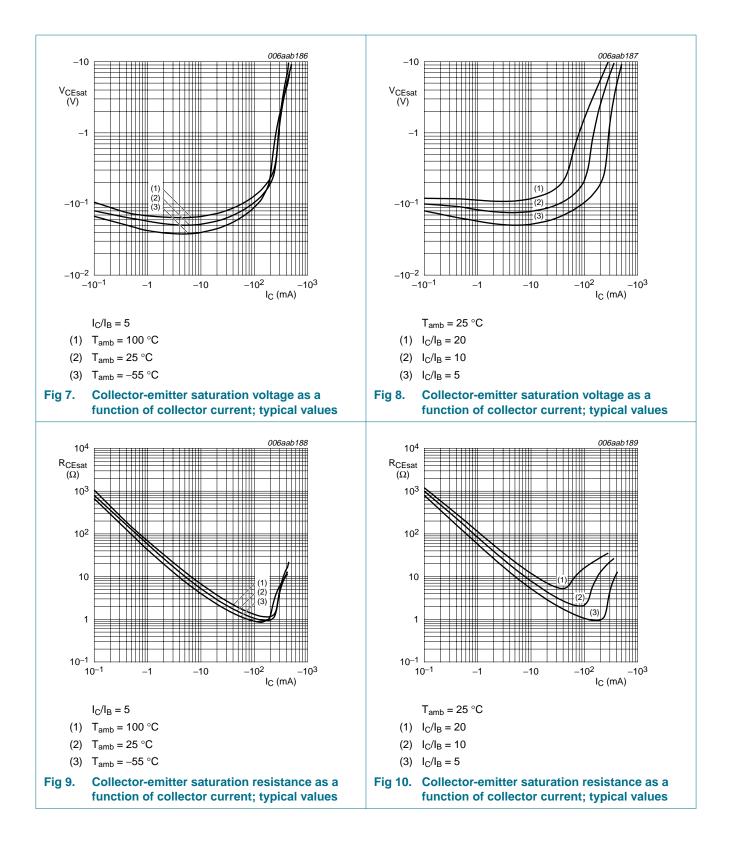
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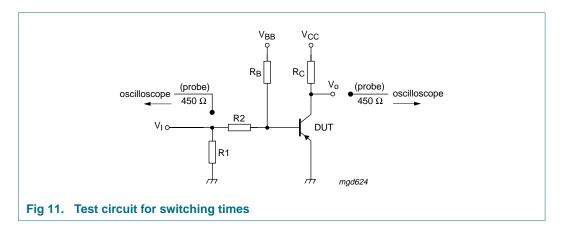
# **PBHV9040T**

#### 500 V, 0.25 A PNP high-voltage low V<sub>CEsat</sub> (BISS) transistor



#### 500 V, 0.25 A PNP high-voltage low V<sub>CEsat</sub> (BISS) transistor

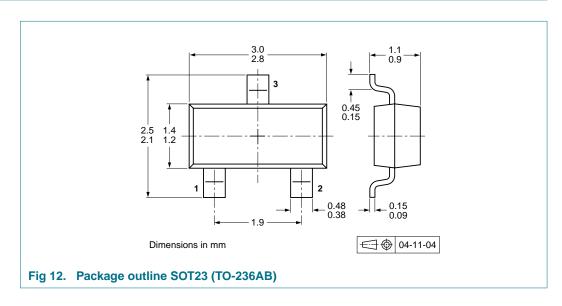
### 8. Test information



### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

### 9. Package outline



### **10. Packing information**

#### Table 8. Packing methods

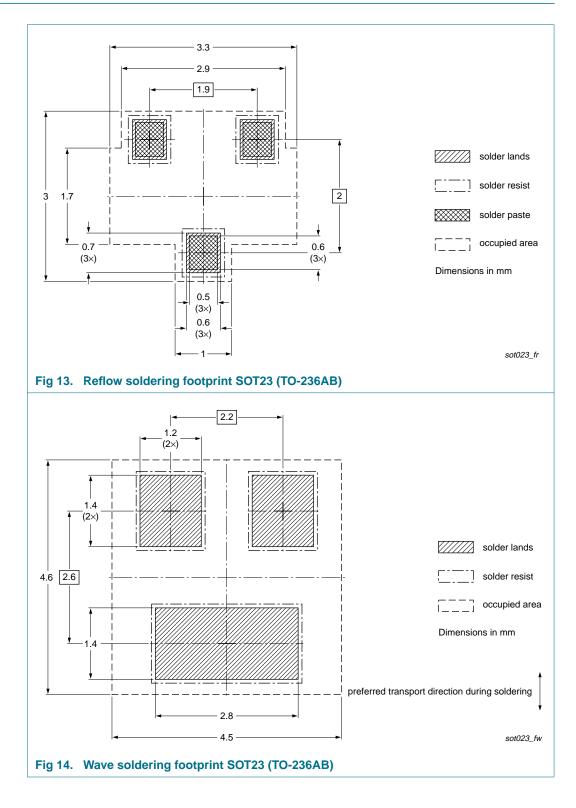
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	quantity
			3000	10000
PBHV9040T	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

### 500 V, 0.25 A PNP high-voltage low V<sub>CEsat</sub> (BISS) transistor

# **11. Soldering**



500 V, 0.25 A PNP high-voltage low V<sub>CEsat</sub> (BISS) transistor

# **12. Revision history**

Document ID	Release date	Data sheet status	Change notice	Supersedes
PBHV9040T_2	20090115	Product data sheet	-	PBHV9040T_1
Modifications:	• Table 5: I <sub>BM</sub>	value changed from -100	mA to -200 mA	
	• <u>Table 7</u> : t <sub>off</sub>	value amended to 1800 ns	;	
	Section 13	"Legal information": update	ed	
PBHV9040T_1	20080212	Product data sheet	-	-

# 13. Legal information

### 13.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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#### **NXP Semiconductors**

# **PBHV9040T**

500 V, 0.25 A PNP high-voltage low V<sub>CEsat</sub> (BISS) transistor

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